

SMALL SIGNAL NPN TRANSISTOR

PRELIMINARY DATA

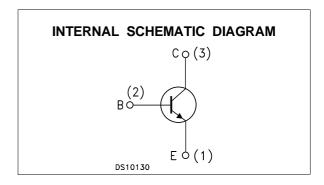
Туре	Marking	
SO642	N91	

- SILICON EPITAXIAL PLANAR NPN HIGH VOLTAGE TRANSISTOR
- MINIATURE SOT-23 PLASTIC PACKAGE FOR SURFACE MOUNTING CIRCUITS
- TAPE AND REEL PACKING
- THE PNP COMPLEMENTARY TYPE IS SO692

APPLICATIONS

- VIDEO AMPLIFIER CIRCUITS (RGB CATHODE CURRENT CONTROL)
- TELEPHONE WIRELINE INTERFACE (HOOK SWITCHES, DIALER CIRCUITS)





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter Value		Unit
V_{CBO}	Collector-Base Voltage (I _E = 0)	300	V
V _{CEO}	Collector-Emitter Voltage (I _B = 0)	300	V
V _{EBO}	Emitter-Base Voltage (I _C = 0)	6	V
Ic	Collector Current	0.1	Α
I _{CM}	Collector Peak Current	0.3	Α
P _{tot}	P_{tot} Total Dissipation at $T_C = 25$ °C 310		mW
T _{stg}	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

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THERMAL DATA

R _{thj-amb} •	Thermal Resistance Junction-Ambient	Max	403.2	°C/W	
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Device mounted on a PCB area of 1 cm²

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

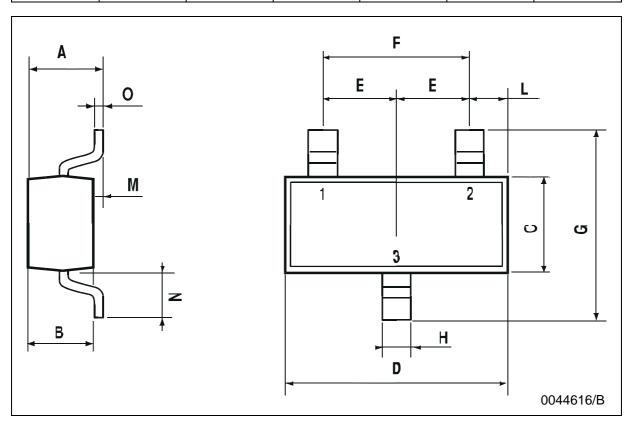
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I _{CBO}	Collector Cut-off Current (I _E = 0)	V _{CB} = 200 V			100	nA
V _{(BR)CBO}	Collector-Emitter Breakdown Voltage (I _E = 0)	I _C = 100 μA	300			V
V _{(BR)CEO*}	Collector-Emitter Breakdown Voltage (I _B = 0)	I _C = 1 mA	300			V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage (I _C = 0)	I _E = 100 μA	6			V
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	$I_C = 20 \text{ mA}$ $I_B = 2 \text{ mA}$			0.5	V
V _{BE(sat)} *	Base-Emitter Saturation Voltage	$I_C = 20 \text{ mA}$ $I_B = 2 \text{ mA}$			0.9	V
h _{FE} *	DC Current Gain	I _C = 1 mA	25 40 40			
f _T	Transition Frequency	I _C = 10 mA V _{CE} = 20 V f = 20 MHz	50			MHz
Ссво	Collector-Base Capacitance	I _E = 0 V _{CB} = 10 V f = 1MHz		6		pF
СЕВО	Emitter-Base Capacitance	$I_C = 0$ $V_{EB} = 2 V f = 1MHz$		22		pF

^{*} Pulsed: Pulse duration = 300 μ s, duty cycle \leq 2 %

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SOT-23 MECHANICAL DATA

DIM.	mm			mils			
Dim.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	0.85		1.1	33.4		43.3	
В	0.65		0.95	25.6		37.4	
С	1.20		1.4	47.2		55.1	
D	2.80		3	110.2		118	
E	0.95		1.05	37.4		41.3	
F	1.9		2.05	74.8		80.7	
G	2.1		2.5	82.6		98.4	
Н	0.38		0.48	14.9		18.8	
L	0.3		0.6	11.8		23.6	
М	0		0.1	0		3.9	
N	0.3		0.65	11.8		25.6	
0	0.09		0.17	3.5		6.7	



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